

PHOTOCOUPLER

PS2561-1,PS2561L-1,PS2561L1-1,PS2561L2-1

HIGH ISOLATION VOLTAGE SINGLE TRANSISTOR TYPE MULTI PHOTOCOUPLER SERIES

-NEPOC Series-

★ DESCRIPTION

The PS2561-1 is optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor.

The PS2561-1 is in a plastic DIP (Dual In-line Package) and the PS2561L-1 is lead bending type (Gull-wing) for surface mount.

The PS2561L1-1 is lead bending type for long creepage distance.

The PS2561L2-1 is lead bending type for long creepage distance (Gull-wing) for surface mount.

FEATURES

- High Isolation voltage (BV = 5 000 Vr.m.s.)
- High collector to emitter voltage (VcEo = 80 V)
- High current transfer ratio (CTR = 200 % TYP.)
- High-speed switching (tr = 3 μ s TYP., tr = 5 μ s TYP.)
- ◆ Ordering number of taping product: PS2561L-1-E3, E4, F3, F4, PS2561L2-1-E3, E4
- ★ Safety standards
 - UL approved: File No. E72422
 - · CSA approved: No. CA 101391
 - BSI approved: No. 7112/7420
 - SEMKO approved: No. 303059, 307244
 - NEMKO approved: No. P03200272, P03200747
 - DEMKO approved: No. 312341, 312340
 - FIMKO approved: No. FI 10620, FI 11898
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

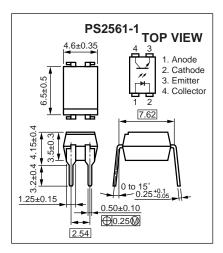
APPLICATIONS

- Power supply
- Telephone/FAX.
- FA/OA equipment
- · Programmable logic controller

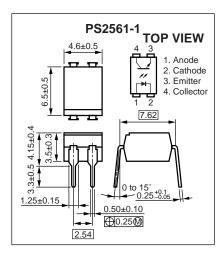
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★ PACKAGE DIMENSIONS (UNIT : mm)

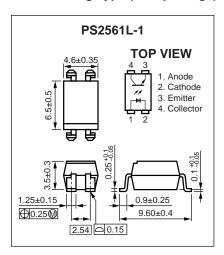
DIP Type (New package)



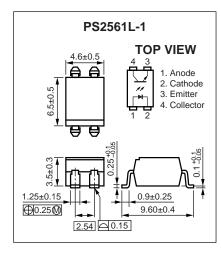
DIP Type



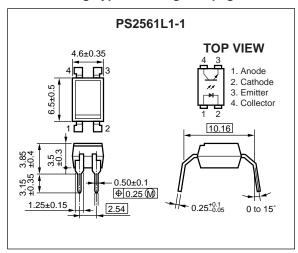
Lead Bending Type (New package)



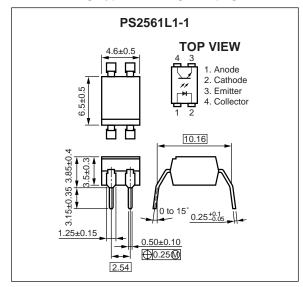
Lead Bending Type



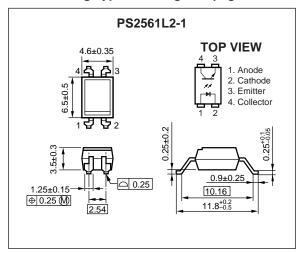
Lead Bending Type For Long Creepage Distance (New Package)



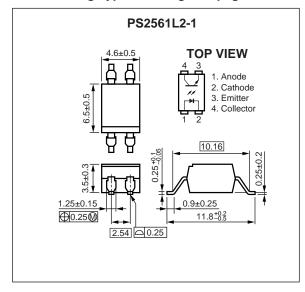
Lead Bending Type For Long Creepage Distance



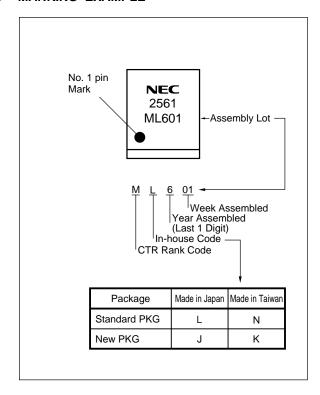
Lead Bending Type For Long Creepage Distance (Gull-Wing) (New Package)



Lead Bending Type For Long Creepage Distance (Gull-Wing)



★ MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS2561-1	PS2561-1-A	Pb-Free	Magazine case 100 pcs	Standard products	PS2561-1
PS2561L-1	PS2561L-1-A			(UL, CSA, BSI,	
PS2561L1-1	PS2561L1-1-A			NEMKO, SEMKO,	
PS2561L2-1	PS2561L2-1-A			DEMKO, FIMKO	
PS2561L-1-E3	PS2561L-1-E3-A		Embossed Tape 1 000 pcs/reel	approved)	
PS2561L-1-E4	PS2561L-1-E4-A				
PS2561L-1-F3	PS2561L-1-F3-A		Embossed Tape 2 000 pcs/reel		
PS2561L-1-F4	PS2561L-1-F4-A				
PS2561L2-1-E3	PS2561L2-1-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L2-1-E4	PS2561L2-1-E4-A				
PS2561-1-V	PS2561-1-V-A		Magazine case 100 pcs	DIN EN60747-5-2	
PS2561L-1-V	PS2561L-1-V-A			(VDE0884 Part2)	
PS2561L1-1-V	PS2561L1-1-V-A			approved products	
PS2561L2-1-V	PS2561L2-1-V-A			(Option)	
PS2561L-1-V-E3	PS2561L-1-V-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L-1-V-E4	PS2561L-1-V-E4-A				
PS2561L-1-V-F3	PS2561L-1-V-F3-A		Embossed Tape 2 000 pcs/reel		
PS2561L-1-V-F4	PS2561L-1-V-F4-A				
PS2561L2-1-V-E3	PS2561L2-1-V-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L2-1-V-E4	PS2561L2-1-V-E4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

★ ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Reverse Voltage	VR	6	V
	Forward Current (DC)	lf	80	mA
	Power Dissipation Derating	⊿P₀/°C	1.5	mW/°C
	Power Dissipation	P□	150	mW
	Peak Forward Current*1	IFP	1	Α
Transistor	Collector to Emitter Voltage	Vceo	80	V
	Emitter to Collector Voltage	Veco	7	V
	Collector Current	lc	50	mA
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C
	Power Dissipation	Pc	150	mW
Isolation Voltage*2		BV	5 000	Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100	°C
Storage Temperature		T _{stg}	-55 to +150	°C

^{*1} PW = 100 \(\mu\)s, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

ELECTRICAL CHARACTERISTICS (TA = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.17	1.4	V
	Reverse Current	lr	V _R = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		50		pF
Transistor	Collector to Emitter Dark Current	Iceo	VcE = 80 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio	CTR	I _F = 5 mA, V _{CE} = 5 V	80	200	400	%
	Collector Saturation Voltage	VCE (sat)	I _F = 10 mA, I _C = 2 mA			0.3	V
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.5		pF
	Rise Time*2	t r	Vcc = 10 V, Ic = 2 mA, RL = 100 Ω		3		μS
	Fall Time*2	tr			5		

★ *1 CTR rank

L : 200 to 400 (%)

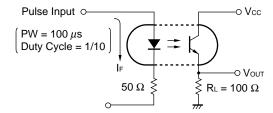
M : 80 to 240 (%)

D : 100 to 300 (%)

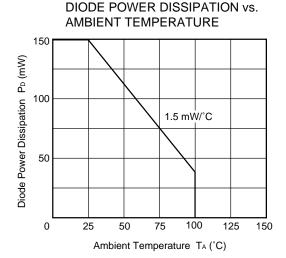
H : 80 to 160 (%)

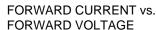
W : 130 to 260 (%)

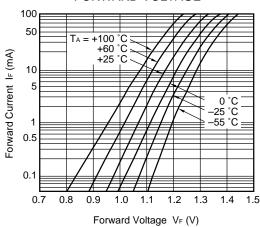
*2 Test circuit for switching time



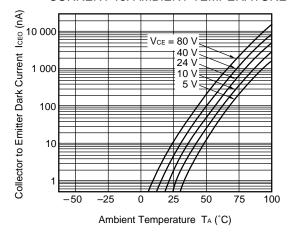
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)





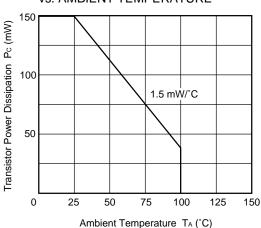


COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

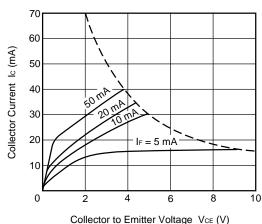


Remark The graphs indicate nominal characteristics.

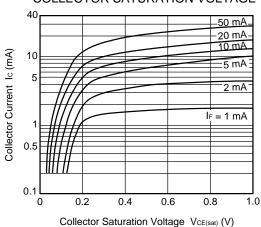




COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



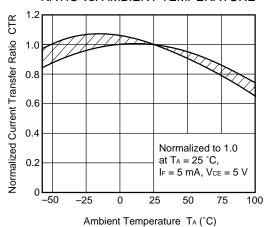
COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**



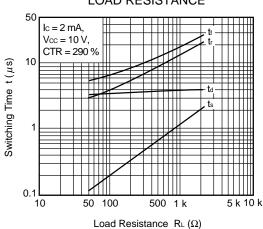
Downloaded from Elcodis.com electronic components distributor

Data Sheet PN10234EJ03V0DS

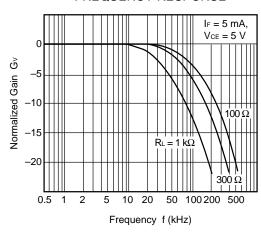
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

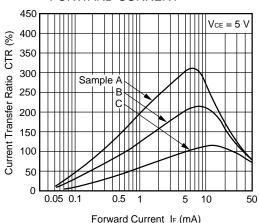


FREQUENCY RESPONSE

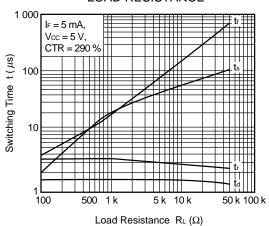


Remark The graphs indicate nominal characteristics.

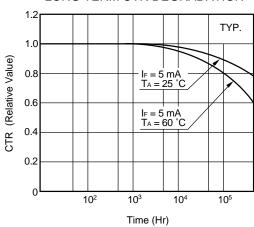
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



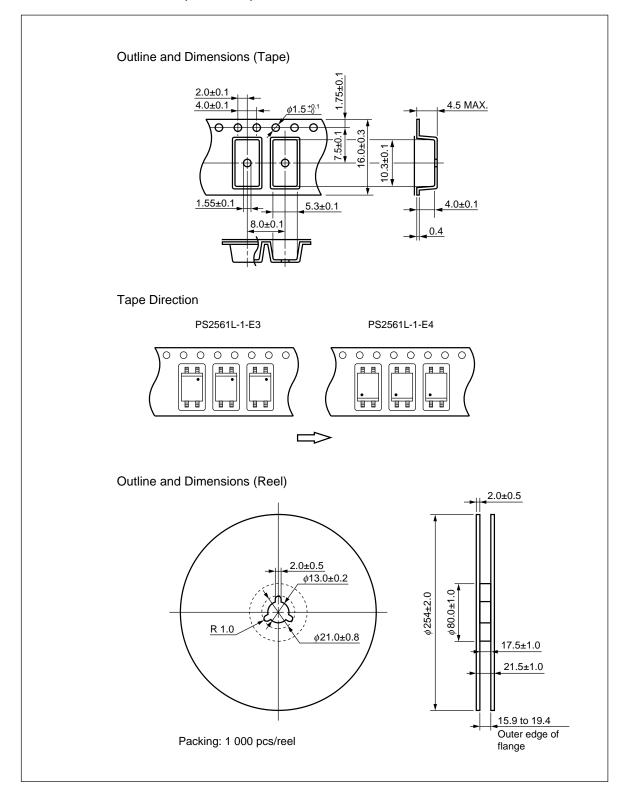
SWITCHING TIME vs. LOAD RESISTANCE

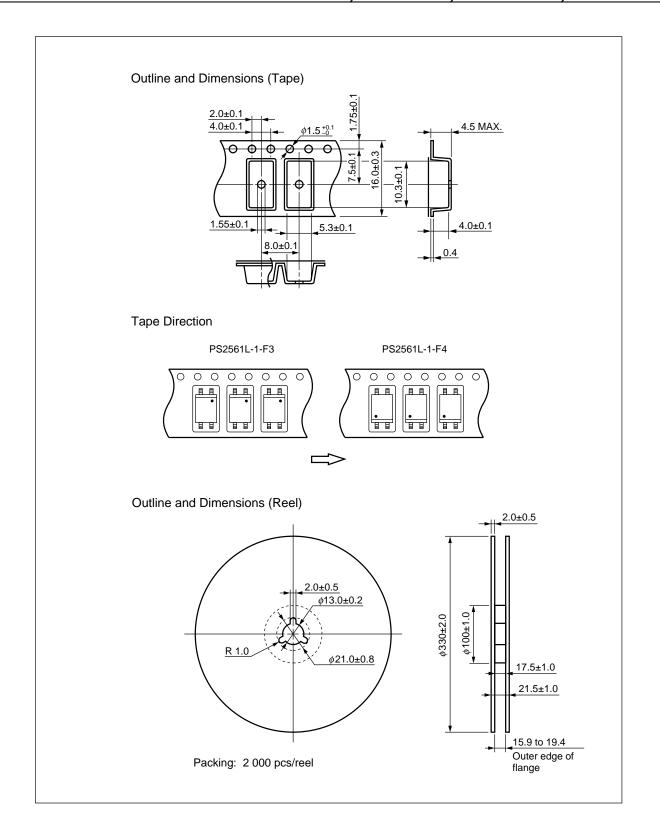


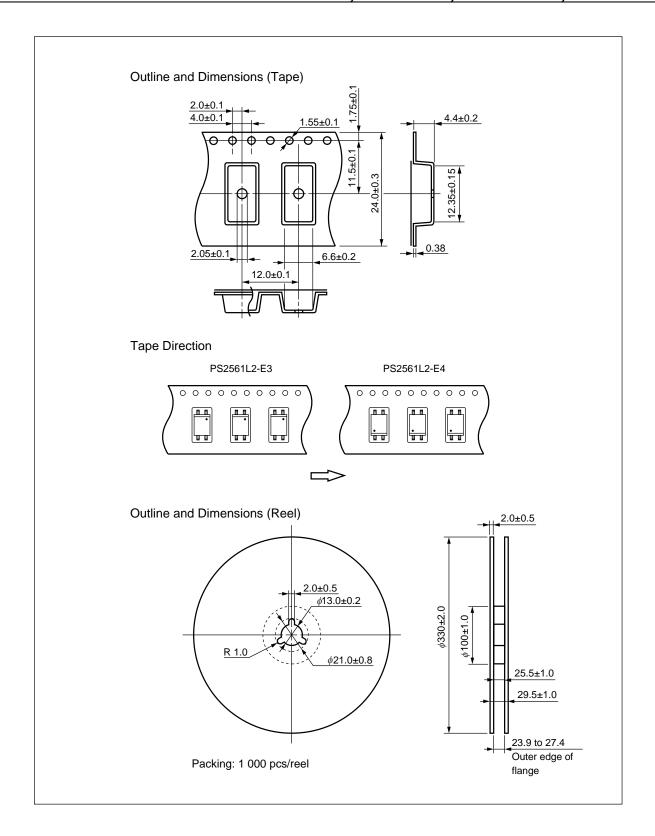
LONG TERM CTR DEGRADATION



★ TAPING SPECIFICATIONS (UNIT : mm)







NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

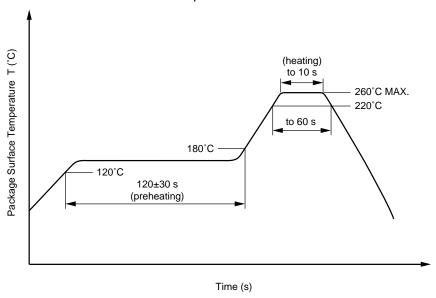
Time of peak reflow temperature
 Time of temperature higher than 220°C
 50 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

★ (3) Soldering by soldering iron

Peak temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below $I_F = 1 \text{ mA}$.

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN VDE 0109) for rated line voltages ≤ 300 Vr.m.s. for rated line voltages ≤ 600 Vr.m.s.		IV III	
Climatic test class (DIN IEC 68 Teil 1/09.80)		55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.2 \times U_{IORM}$, $P_d < 5 pC$	Ulorm Upr	890 1 068	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices test) $U_{pr} = 1.6 \times U_{IORM}, \ P_d < 5 \ pC$	U_pr	1 424	V_{peak}
Highest permissible overvoltage	Utr	8 000	V _{peak}
Degree of pollution (DIN VDE 0109)		2	
Clearance distance		> 7.0	mm
Creepage distance		> 7.0	mm
Comparative tracking index (DIN IEC 112/VDE 0303 part 1)	CTI	175	
Material group (DIN VDE 0109)		III a	
Storage temperature range	Tstg	-55 to +150	°C
Operating temperature range	TA	-55 to +100	°C
Isolation resistance, minimum value $V_{IO} = 500 \ V \ dc \ at \ T_A = 25 \ ^{\circ}C$ $V_{IO} = 500 \ V \ dc \ at \ T_A \ MAX. \ at \ least \ 100 \ ^{\circ}C$	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I _F , Psi = 0) Power (output or total power dissipation) Isolation resistance	Tsi Isi Psi	175 400 700	°C mA mW
$V_{IO} = 500 \text{ V dc}$ at $T_A = 175 \text{ °C}$ (Tsi)	Ris MIN.	10 ⁹	Ω

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(Note)

and industrial robots

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M8E 00.4-0110

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CELI California Eastern Laboratories PS2561-1,PS2561L-1,PS2561L1-1,PS2561L2-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶For further information, please contact

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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